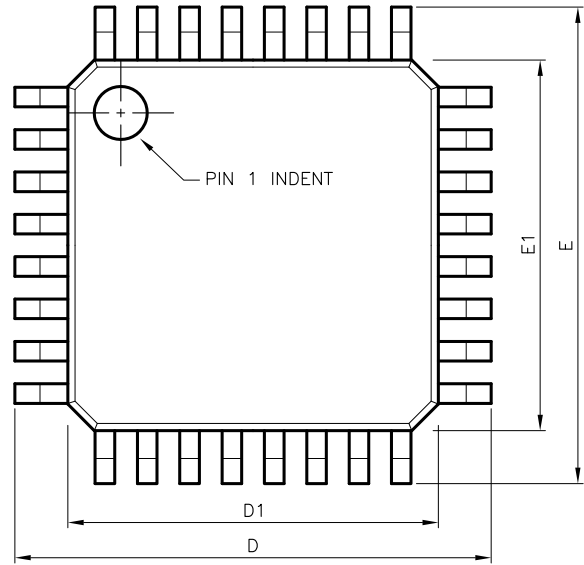
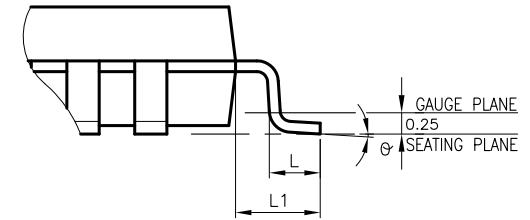
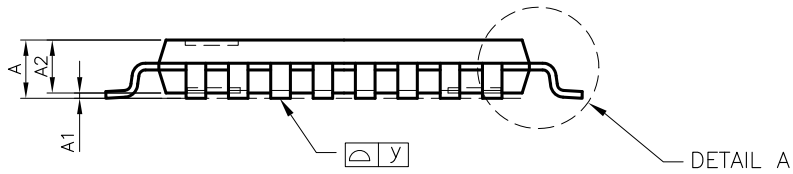
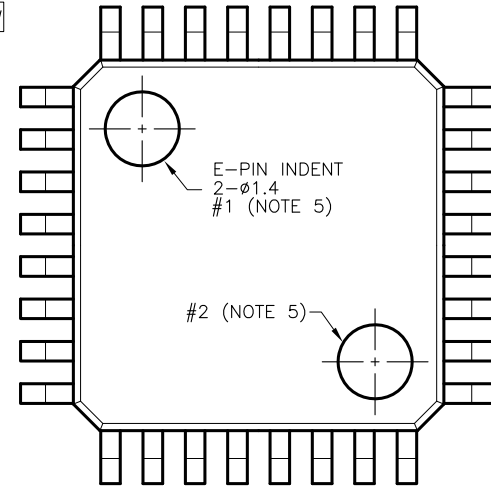


TOP VIEW



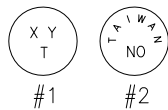
BOTTOM VIEW



DETAIL A

NOTE :

- CONTROLLING DIMENSION : mm
- LEAD FRAME MATERIAL : COPPER C7025
- PACKAGE DIMENSION EXCLUSIVE MOLDING FLASH
ALLOWABLE PROTURSION IS 0.25 mm PER SIDE
- DIMENSION b DOES NOT INCLUDE DAMBER PROTURSION.
ALLOWABLE DAMBER PROTURSION SHALL NOT CAUSE THE
LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION
BY MORE THEN 0.08 mm.
- BOTTOM E-PIN INDENT ARE MARKED AS
BELOW :



X : A, B, C, ...
Y : 1 ~ 12

NO : DENOTE MOLD
SET NUMBER

- ALL EDGE CORNER TO BE R 0.20 MAX.
- JEDEC NUMBER : MS-026

SYMBOL	DIMENSIONS IN MILLIMETERS		
	MIN.	NOM.	MAX.
A	—	—	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
b	0.30	0.37	0.45
C	0.09	—	0.20
E	—	9.00	—
E1	—	7.00	—
D	—	9.00	—
D1	—	7.00	—
e	—	0.80	—
L	0.45	0.60	0.75
L1	—	1.00	—
Ø	0°	3.5°	7°
y	0.0	—	0.10

CUSTOMER :		LINGSEN 5-1 NAN 2ND ROAD T.E.P.Z. PRECISION IND., LTD. TAICHUNG, TAIWAN, R. O. C.	
APPROVED BY	DATE	TITLE:	
DRAW BY: <i>Vicky Chen</i>	07/21/98	32L TQFP PACKAGE OUTLINE DRAWING (7x7x1.0 mm) (2.0 mm FOOTPRINT)	
CHECK BY: <i>Thomas Kao</i>	7/24/98	DWG. NO.	REV.
APPROVAL: <i>Paul Liu</i>	7/30/98	PO-TQFP-003	0
APPROVAL: <i>Barry Chen</i>	7/31/98	UNIT : mm	SCALE : 10/1
		SHEET 1 OF 1	